



# PRODUCT DATASHEET



- EMC SMD Top View
  3528 1.3t Series
- Infrared (IR) 940nm

# NOF60S81BS (VCSEL Flood)







AEC-0102

# **FEATURES:**

- Package: Ceramic Asymmetric VCSEL with Black Mask
- Forward Current: 5A (tp=300µs, DC=5%)
- Forward Voltage (typ.): 2.3V
- Radiant Power (typ.): 4000mW@5A
- Colour: Infrared (IR)
- Peak Wavelength (typ.): 940nm
- Field of Illumination: 60° x 45°
- Materials:
  - Resin: Glass (Water Diffused)
  - L/T Finish: Au plated
- Operating Temperature: -40~+125°C
- Storage Temperature: -40~+125°C
- Grouping parameters:
  - Forward Voltage
  - Radiant Power
  - Peak Wavelength
- Soldering methods: Reflow
- Preconditioning: MSL2 according to J-STD020

3528 1.3t Series

# **APPLICATIONS:**

- Automotive
- Security Camera
- Motion Detection
- Night Viewer
- Surveillance
- 3D Sensing

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- Facial / Gesture Recognition
- Virtual Reality



# CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Pulse Forward Current (100µs; Duty Cycle 2%)	Ipf	8	А
Power Consumption	P <sub>tot</sub>	21.5	W
Junction Temperature	Tj	145	°C
Thermal Resistance Junction to Solder Point	Rth	10	K/W
Temperature Coefficient of Wavelength	$\Lambda_{Shift}$	0.07	nm/K
ESD withstand voltage HBM: H3A <sup>1</sup>	Vesd-hbm	8	kV
ESD withstand voltage CDM: C2b <sup>2</sup>	V <sub>ESD-CDM</sub>	750	V
Operating Temperature	Topr	-40~+125	°C
Storage Temperature	Т <sub>stg</sub>	-40~+125	°C
Soldering Temperature	Tsol	260	°C

1. According to AEC-Q101-001-Rev.A.

2. According to AEC-Q101-005-Rev.A.

Parameter	Symbol	Values			Unit	Test
		Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF		2.3	2.7	V	I⊧=5A
Radiant Power	$\Phi_{e}$		4		W	I⊧=5A
Peak Wavelength	$\Lambda_{P}$		940		nm	I⊧=5A
Spectral Bandwidth	Δλ		4		nm	I⊧=5A
Field of Illumination (FOI) at FWHM	θн		60		deg	I⊧=5A
	Өн		45			

### VCSEL Characteristics (Ta=25°C, I<sub>F</sub>=5A, t<sub>p</sub>=300µs, DC=5%)

1. Radiant Power (P\_0)  $\pm 10\%$ , Forward Voltage (V\_F)  $\pm 0.1V$ , Viewing angle( $2\theta_{1/2}$ )  $\pm 10^{\circ}$ 

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# **CHARACTERISTICS:**

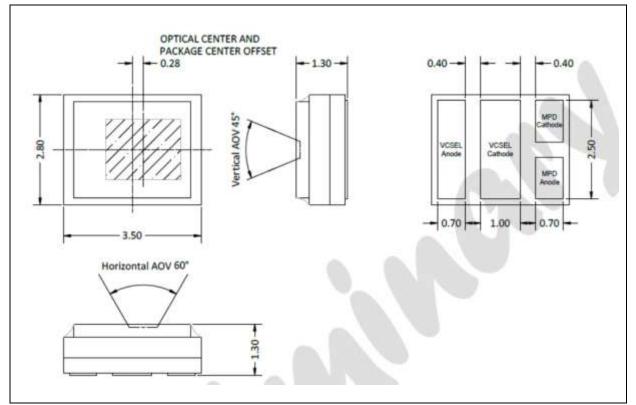
## Monitor Photodiode (MPD) Characteristics (Ta=25°C)

Daramatar	Sumbol	Values			Unit	Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Forward Voltage	VF	0.5		1.3	V	I⊧=10mA
Peak Sensing Wavelength	$\Lambda_{PS}$		940		nm	
Spectral Range	٨	400		1100	nm	
Light Current	١L		2		μΑ	$V_{R}=5V$ , $E_{e}=1mW/cm^{2}$
Reverse Breakdown Voltage	VBR			35	V	I <sub>R</sub> =100μΑ
Reverse Dark Current	ID			10	nA	



## **OUTLINE DIMENSION:**

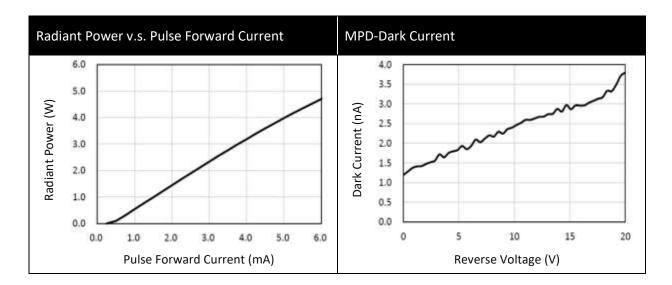
## Package Dimension:

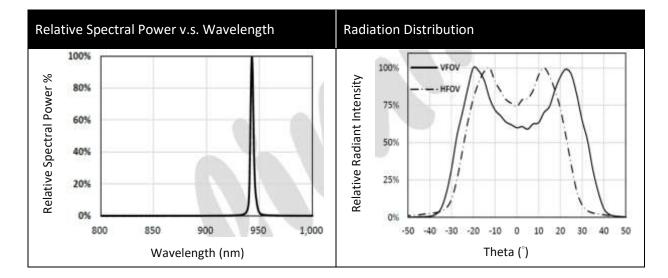


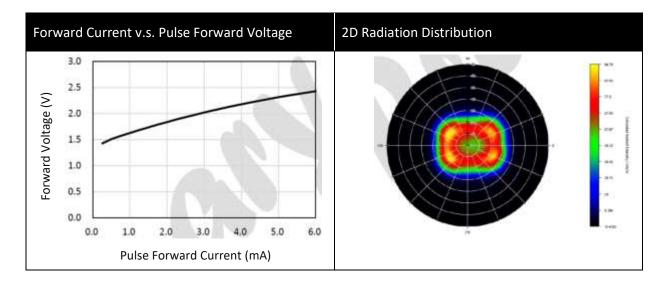
- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.



## **ELECTRO-OPTICAL CHARACTERISTICS:**

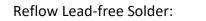


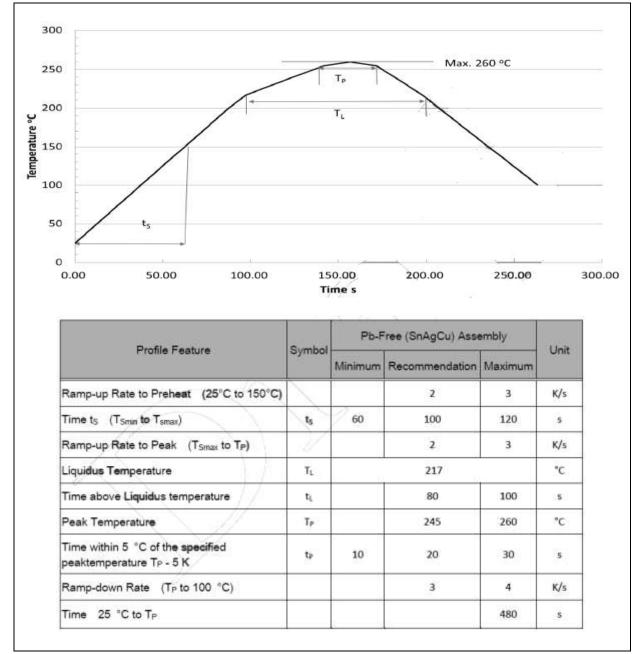






## **RECOMMENDED SOLDERING PROFILE:**





Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Recommended soldering temperature is 245°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.

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## **PRECAUTIONS OF USE:**



### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

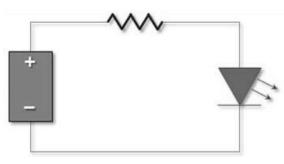
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	24/05/2022	Datasheet set-up.